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Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

Rev. 1 — 29 January 2013

Product data sheet

1. General description

The 74LVC573A-Q100 consists of eight D-type transparent latches, featuring separate D-type inputs for each latch and 3-state true outputs for bus-oriented applications. A Latch Enable (LE) input and an Output Enable (\overline{OE}) input are common to all internal latches.

When LE is HIGH, data at the Dn inputs enters the latches. In this condition, the latches are transparent, that is, a latch output changes each time its corresponding D-input changes. When LE is LOW, the latches store the information that was present at the D-inputs one set-up time preceding the HIGH-to-LOW transition of LE.

When \overline{OE} is LOW, the contents of the eight latches are available at the outputs. When \overline{OE} is HIGH, the outputs go to the high impedance OFF-state. Operation of the \overline{OE} input does not affect the state of the latches.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices as translators in mixed 3.3 V or 5 V applications.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

2. Features and benefits

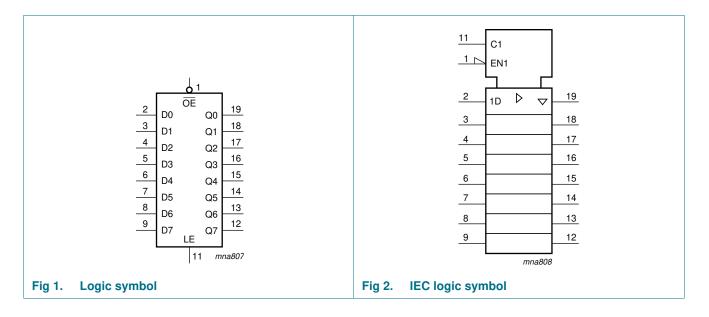
- Automotive product qualification in accordance with AEC-Q100 (Grade 1)
 - Specified from -40 °C to +85 °C and from -40 °C to +125 °C
- 5 V tolerant inputs/outputs, for interfacing with 5 V logic
- Supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- Flow-through pinout architecture
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



3. Ordering information

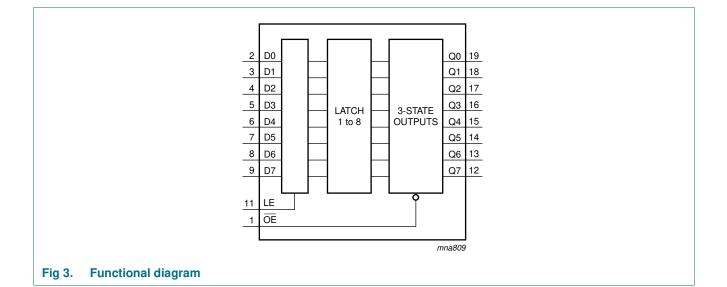
Table 1. Ordering in	nformation									
Type number	Package	Package								
	Temperature range	Name	Description	Version						
74LVC573AD-Q100	–40 °C to +125 °C	SO20	plastic small outline package; 20 leads; body width 7.5 mm	SOT163-1						
74LVC573APW-Q100	–40 °C to +125 °C	TSSOP20	plastic thin shrink small outline package; 20 leads; body width 4.4 mm	SOT360-1						
74LVC573ABQ-Q100	–40 °C to +125 °C	DHVQFN20	plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body $2.5 \times 4.5 \times 0.85$ mm	SOT764-1						

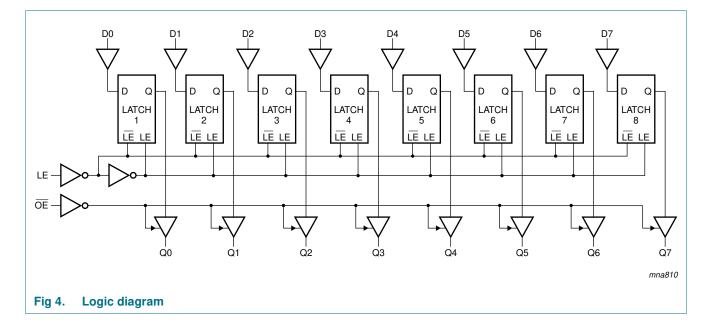
4. Functional diagram



74LVC573A-Q100

Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state





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5. Pinning information

5.1 Pinning

74LVC573A-Q100 202 terminal 1 Ы index area 20 -2 (19 Q0 74LVC573A-Q100 D0 D1 (18 Q1 3) OE 1 20 V_{CC} (17 D2 4) Q2 D0 2 19 Q0 (16 D3 5) Q3 18 Q1 D1 3 6) D2 4 17 Q2 D4 (15 Q4 D3 5 16 Q3 7) D5 (14 Q5 15 Q4 D4 6 D6 8) (13 Q6 GND⁽¹⁾ D5 7 14 Q5 D7 9) (12 Q7 13 Q6 D6 8 Ē P 12 Q7 D7 9 Щ GND aaa-006117 GND 10 11 LE aaa-006116 Transparent top view (1) This is not a supply pin. The substrate is attached to this pad using conductive die attach material. There is no electrical or mechanical requirement to solder this pad. However, if it is soldered, the solder land should remain floating or be connected to GND. Fig 5. Pin configuration for SO14 and TSSOP14 Fig 6. Pin configuration for DHVQFN14

5.2 Pin description

Table 2.	Pin description	
Symbol	Pin	Description
OE	1	output enable input (active LOW)
LE	11	latch enable input (active HIGH)
D[0:7]	2, 3, 4, 5, 6, 7, 8, 9	data input
Q[0:7]	19, 18, 17, 16, 15, 14, 13, 12	data output
GND	10	ground (0 V)
V _{CC}	20	supply voltage

6. Functional description

Table 3.Functional table^[1]

Operating modes	Input		Internal latch	Output	
	OE	LE	Dn		Qn
Enable and read register	L	Н	L	L	L
(transparent mode)	L	Н	Н	Н	Н
Latch and read register	L	L	Ι	L	L
	L	L	h	Н	Н
Latch register and disable outputs	Н	L	I	L	Z
	Н	L	h	Н	Z

[1] H = HIGH voltage level

h = HIGH voltage level one set-up time prior to the HIGH-to-LOW LE transition

L = LOW voltage level

I = LOW voltage level one set-up time prior to the HIGH-to-LOW LE transition

Z = high-impedance OFF-state

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Мах	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V ₁ < 0	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{\rm O}$ > $V_{\rm CC}$ or $V_{\rm O}$ < 0	-	±50	mA
Vo	output voltage		<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
lo	output current	$V_{O} = 0$ V to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C$	<u>[3]</u> _	500	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

 $\begin{array}{ll} \mbox{[3]} & \mbox{For SO20 packages: above 70 °C the value of P_{tot} derates linearly with 8 mW/K. \\ & \mbox{For TSSOP20 packages: above 60 °C the value of P_{tot} derates linearly with 5.5 mW/K. \\ & \mbox{For DHVQFN20 packages: above 60 °C the value of P_{tot} derates linearly with 4.5 mW/K. \\ \end{array}$

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Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

Recommended operating conditions 8.

Table 5.	Recommended operating condition	ons				
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	-	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH- or LOW-state	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	V _{CC} = 1.65 V to 2.7 V	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	0	-	10	ns/V

Static characteristics 9.

Table 6. **Static characteristics**

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to	Unit	
			Min	Typ <mark>[1]</mark>	Max	Min	Max	1
V _{IH}	HIGH-level	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	input voltage	$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V
VIL	LOW-level	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	input voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
	$V_{CC} = 2.7 \text{ V} \text{ to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
output voltage	$I_{O} = -100 \ \mu A;$ $V_{CC} = 1.65 \ V \text{ to } 3.6 \ V$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V
V _{OL}	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	۷
		I _O = 4 mA; V _{CC} = 1.65 V	-	-	0.45	-	0.65	V
		$I_{O} = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		$I_{O} = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V
		$I_{O} = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current	V_{CC} = 3.6 V; V_{I} = 5.5 V or GND	-	±0.1	±5	-	±20	μA

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Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

Symbol	Parameter	Conditions	-40) °C to +85	°C	–40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
I _{OZ}	OFF-state output current	$\label{eq:VI} \begin{array}{l} V_{I} = V_{IH} \text{ or } V_{IL}; \ V_{CC} = 3.6 \ V; \\ V_{O} = 5.5 \ V \text{ or } GND; \end{array}$	-	0.1	±5	-	±20	μA
I _{OFF}	power-off leakage current	V_{CC} = 0 V; V _I or V _O = 5.5 V	-	0.1	±10	-	±20	μA
I _{CC}	supply current	$\label{eq:V_CC} \begin{array}{l} V_{CC} = 3.6 \ V; \ V_{I} = V_{CC} \ \text{or GND}; \\ I_{O} = 0 \ A \end{array}$	-	0.1	10	-	40	μA
∆l _{CC}	additional supply current	per input pin; V _{CC} = 2.7 V to 3.6 V; V _I = V _{CC} – 0.6 V; I _O = 0 A	-	5	500	-	5000	μA
Cı	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	5.0	-	-	-	pF

Table 6. Static characteristics ...continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to +125 °C		Unit
				Min	Typ <mark>[1]</mark>	Max	Min	Max	
t _{pd}	propagation delay	Dn to Qn; see Figure 7	[2]						
		V _{CC} = 1.2 V		-	16.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.1	7.8	16.3	2.1	18.8	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.1	8.0	1.5	9.2	ns
		$V_{CC} = 2.7 V$		1.5	4.1	7.2	1.5	9.0	ns
	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.4	6.2	1.5	8.0	ns	
		LE to Qn; see Figure 8	[2]						
		V _{CC} = 1.2 V		-	16.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		2.0	7.7	16.0	2.0	18.4	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.1	7.8	1.5	9.1	ns
		$V_{CC} = 2.7 V$		1.5	3.7	7.5	1.5	9.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.4	6.5	1.5	8.5	ns
t _{en}	enable time	OE to Qn; see Figure 9	[2]						
		V _{CC} = 1.2 V		-	18.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.7	7.5	17.5	1.7	20.2	ns
		V_{CC} = 2.3 V to 2.7 V		1.5	4.2	9.2	1.5	10.6	ns
		$V_{CC} = 2.7 V$		1.5	4.2	8.5	1.5	11.0	ns
		$V_{CC} = 3.0 V \text{ to } 3.6 V$		1.5	3.4	7.5	1.5	9.5	ns

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Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	Unit	
				Min	Typ[1]	Max	Min	Max	1
t _{dis}	disable time	OE to Qn; see Figure 9	[2]						
		$V_{CC} = 1.2 V$		-	8.0	-	-	-	ns
	$V_{CC} = 1.65 \text{ V}$ to 1.95 V		1.0	3.3	10.1	1.0	11.6	ns	
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		0.3	1.8	5.7	0.3	6.6	ns
		$V_{CC} = 2.7 V$		1.5	3.0	6.5	1.5	8.5	ns
	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	2.5	6.0	1.5	7.5	ns	
tw	pulse width	LE HIGH; see Figure 8							
	V _{CC} = 1.65 V to 1.95 V		5.0	-	-	5.0	-	ns	
	V_{CC} = 2.3 V to 2.7 V		4.0	-	-	4.0	-	ns	
	$V_{CC} = 2.7 V$		3.2	-	-	3.2	-	ns	
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		3.2	1.6	-	3.2	-	ns
t _{su}	set-up time	nD to nCP; see <u>Figure 10</u>							
		V _{CC} = 1.65 V to 1.95 V		4.0	-	-	4.0	-	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		2.5	-	-	2.5	-	ns
		$V_{CC} = 2.7 V$		1.7	-	-	1.7	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.7	-	-	1.7	-	ns
t _h	hold time	Dn to LE; see Figure 10							
		V _{CC} = 1.65 V to 1.95 V		3.0	-	-	3.0	-	ns
		$V_{CC} = 2.3 \text{ V} \text{ to } 2.7 \text{ V}$		1.9	-	-	1.9	-	ns
		$V_{CC} = 2.7 V$		1.5	-	-	1.5	-	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.4	-	-	1.4	-	ns
t _{sk(o)}	output skew time	$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	[3]	-	-	1.0	-	1.5	ns
C _{PD}	power dissipation	per latch; $V_I = GND$ to V_{CC}	[4]						
	capacitance	V _{CC} = 1.65 V to 1.95 V		-	7.1	-		-	pF
		V_{CC} = 2.3 V to 2.7 V		-	10.3	-		-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	13.2	-		-	pF

Table 7. Dynamic characteristics ... continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 11.

[1] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3] Skew between any two outputs of the same package switching in the same direction. This parameter is guaranteed by design.

[4] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

 C_L = output load capacitance in pF

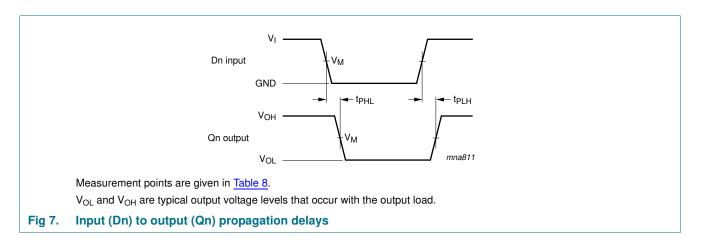
 V_{CC} = supply voltage in Volts

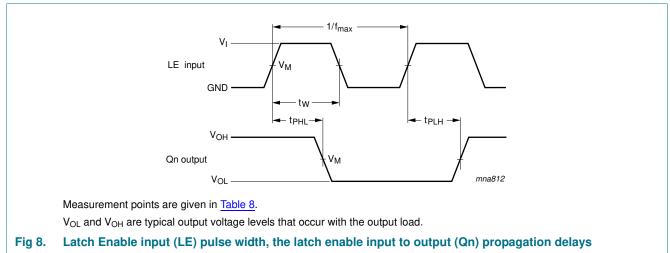
N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs

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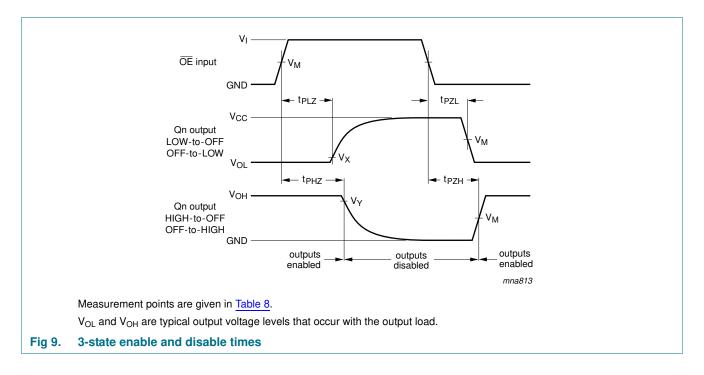
11. AC waveforms





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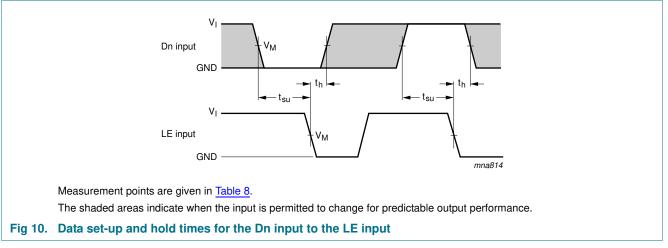


Table 8. Measurement points

Supply voltage	Input		Output	Output				
V _{CC}	VI	V _M	V _M	V _X	V _Y			
1.2 V	V _{CC}	$0.5 \times V_{\text{CC}}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
1.65 V to 1.95 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.3 V to 2.7 V	V _{CC}	$0.5\times V_{CC}$	$0.5\times V_{CC}$	V _{OL} + 0.15 V	V _{OH} – 0.15 V			
2.7 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 V$			
3.0 V to 3.6 V	2.7 V	1.5 V	1.5 V	V _{OL} + 0.3 V	$V_{OH} - 0.3 V$			

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Product data sheet

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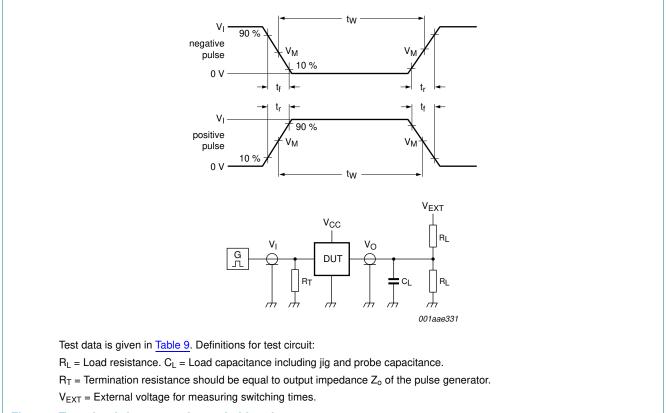


Fig 11. Test circuit for measuring switching times

Table 9. Test data

Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

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12. Package outline

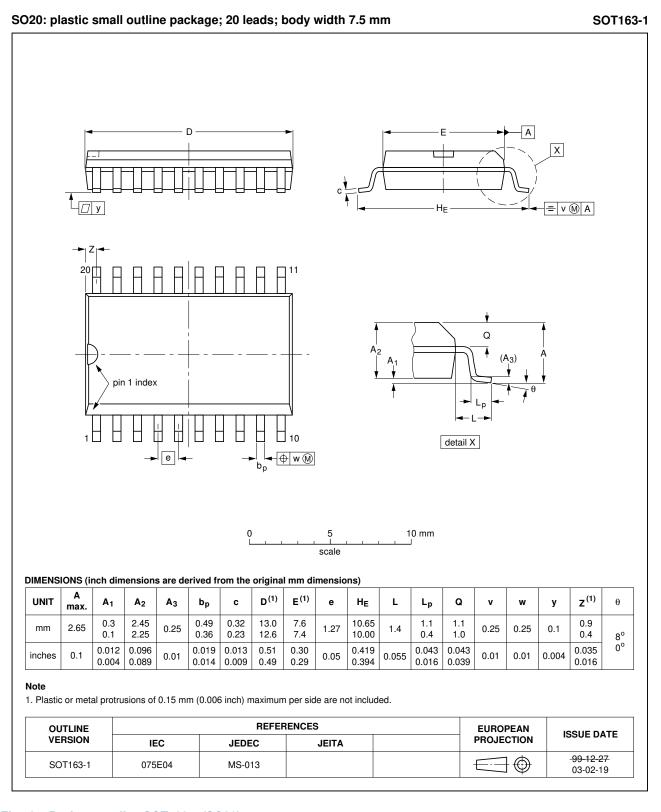


Fig 12. Package outline SOT163-1 (SO20)

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Octal D-type transparent latch with 5 V tolerant inputs/outputs; 3-state

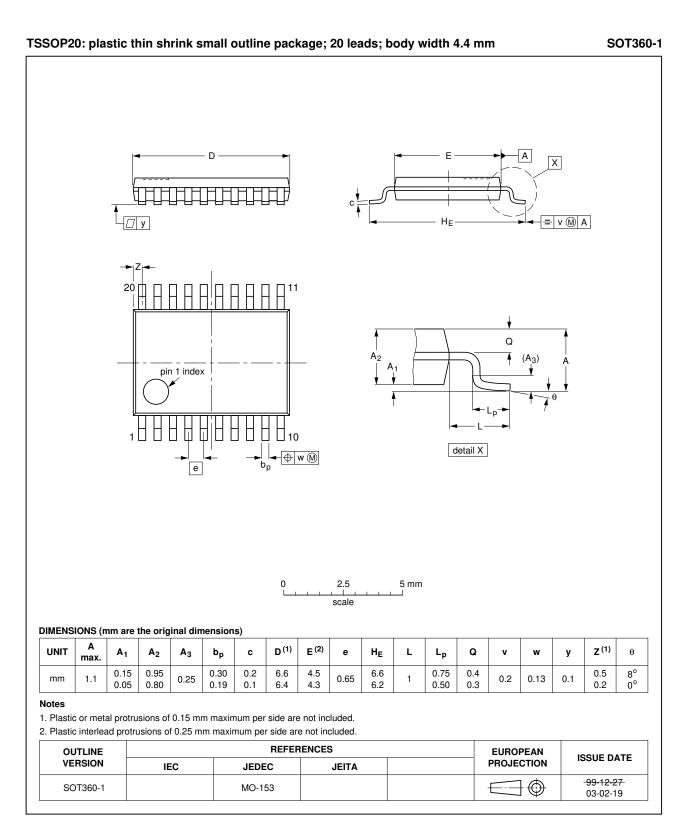
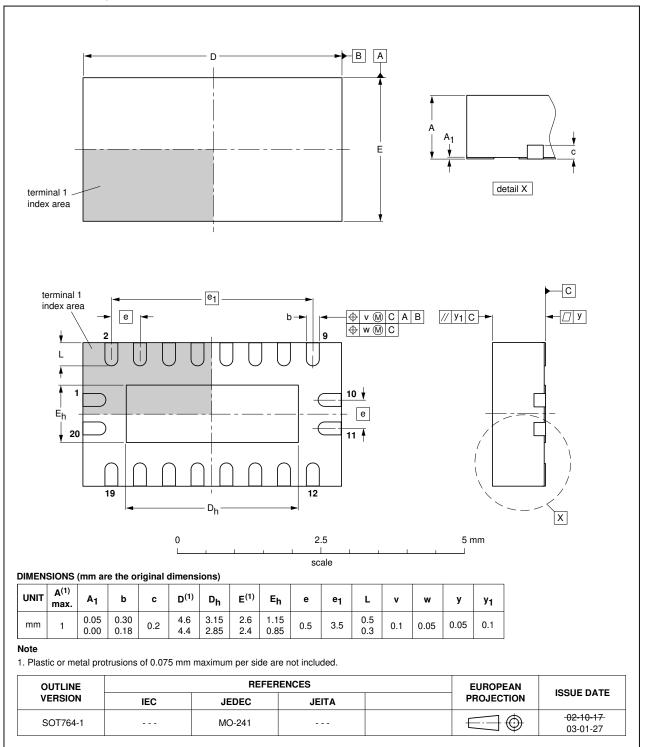


Fig 13. Package outline SOT360-1 (TSSOP20)

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DHVQFN20: plastic dual in-line compatible thermal enhanced very thin quad flat package; no leads; 20 terminals; body 2.5 x 4.5 x 0.85 mm SOT764-1

Fig 14. Package outline SOT764-1 (DHVQFN20)

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13. Abbreviations

Table 10.	Abbreviations
Acronym	Description
CDM	Charged Device Model
DUT	Device Under Test
ESD	ElectroStatic Discharge
HBM	Human Body Model
MIL	Military
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC573A_Q100 v.1	20130129	Product data sheet	-	-	

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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